

Supplementary Information

Facile fabrication of *n*-type flexible CoSb_{3-x}Te_x skutterudite/PEDOT:PSS hybrid thermoelectric films

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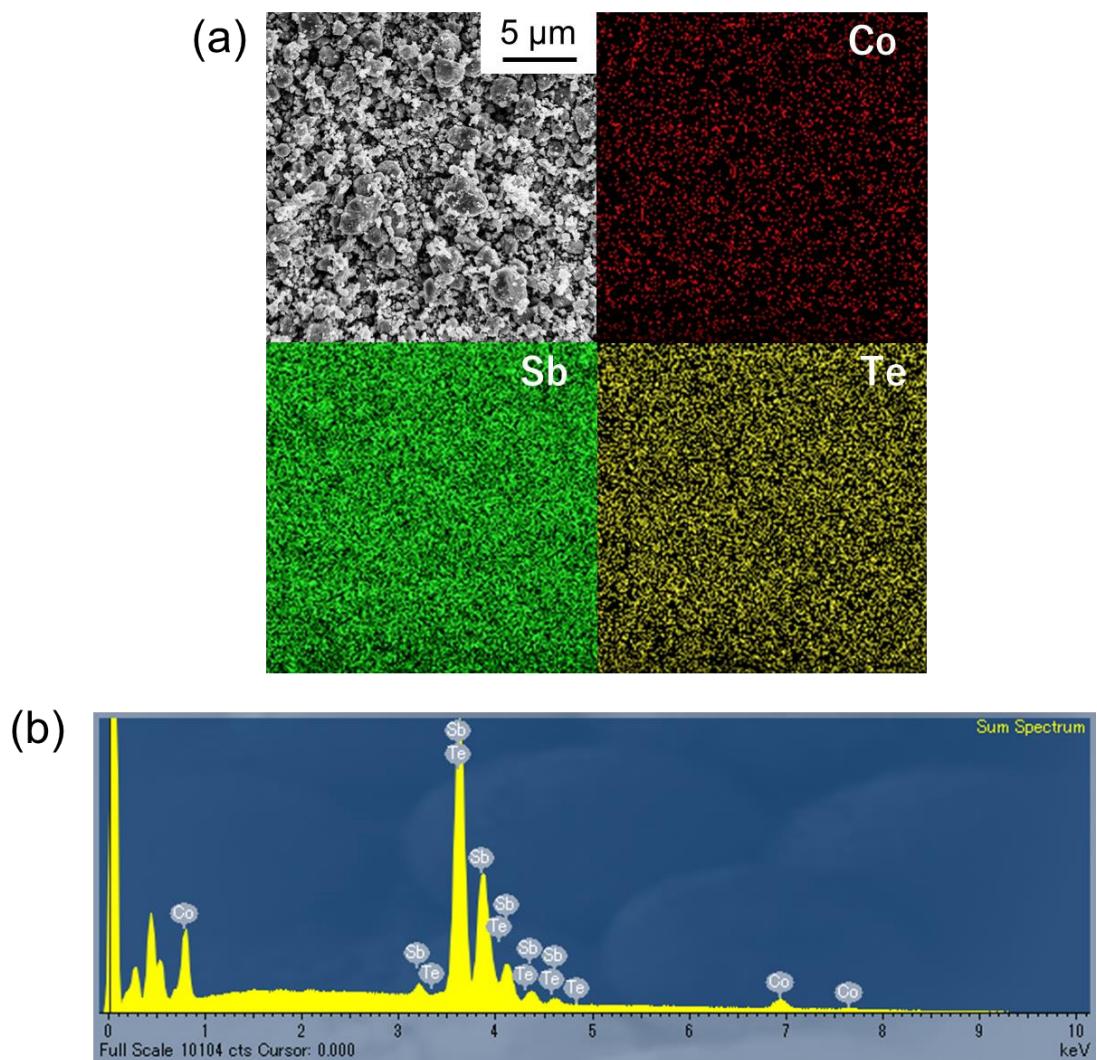


Figure S1. (a) SEM image and EDX mapping images of the ball-milled $\text{CoSb}_{2.95}\text{Te}_{0.05}$ powder; (b) the corresponding EDX spectrum.

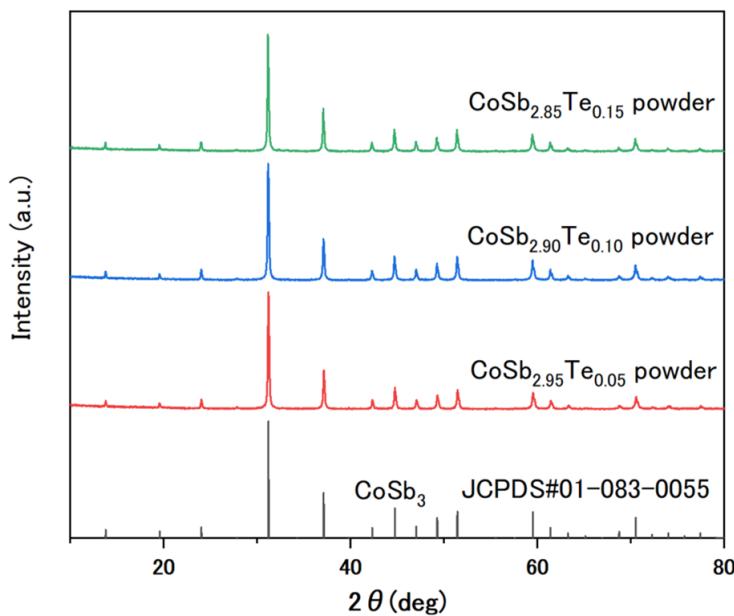


Figure S2. XRD patterns of the ball-milled $\text{CoSb}_{3-x}\text{Te}_x$ powder with different amount of Te dopants ($x = 0.05, 0.10, 0.15$).

Table S1. Cell parameters and reliability factors obtained from Rietveld refinement of XRD patterns ($\lambda_{\text{Cu}} = 1.54056 \text{ \AA}$) of the $\text{CoSb}_{3-x}\text{Te}_x$ ball milled powders and $X\text{CoSb}_{2.95}\text{Te}_{0.05} / 1-X$ PEDOT:PSS hybrid films

CoSb _{3-x} Te _x ball milled powders					
sample	a (Å)	V (Å ³)	R _{Bragg}	R _F	Chi ²
x=0.15	9.0501	741.2	4.13	4.13	1.48
x=0.10	9.0487	740.9	4.82	4.2	1.49
x=0.05	9.0413	739.1	4.27	4.27	1.44
XCoSb _{2.95} Te _{0.05} / 1-X PEDOT:PSS films					
X = 20%	9.0405	738.9	4.45	4.91	1.20
X = 40%	9.0367	737.9	3.43	3.58	1.38
X = 60%	9.0367	737.9	3.81	4.3	1.39
X = 80%	9.0358	737.7	5.96	5.07	1.58
X = 95%	9.0368	738.0	5.88	4.72	1.75
X = 97%	9.0401	738.1	3.65	3.07	1.54
X = 98%	9.0375	738.1	8.24	6.08	2.03

Table S2. Thermoelectric properties of PEDOT:PSS with 5 vol% of DMSO and the $\text{CoSb}_{2.95}\text{Te}_{0.05}$ skutterudite film sample at room temperature.

	Seebeck coefficient [$\mu\text{V/K}$]	Electrical conductivity [S/cm]	Power factor [$\mu\text{W/m K}^2$]	Thermal conductivity [W/m K]
PEDOT:PSS (DMSO 5vol%)	16.8	1195	33.8	0.27 [1]
$\text{CoSb}_{2.95}\text{Te}_{0.05}$ powder film	-174.8	0.031	0.096	7.33*

* The thermal conductivity of the $\text{CoSb}_{2.95}\text{Te}_{0.05}$ powder film is substituted by the thermal conductivity of the $\text{CoSb}_{2.95}\text{Te}_{0.05}$ bulk sample to plot the series-connected model in Figure 3.

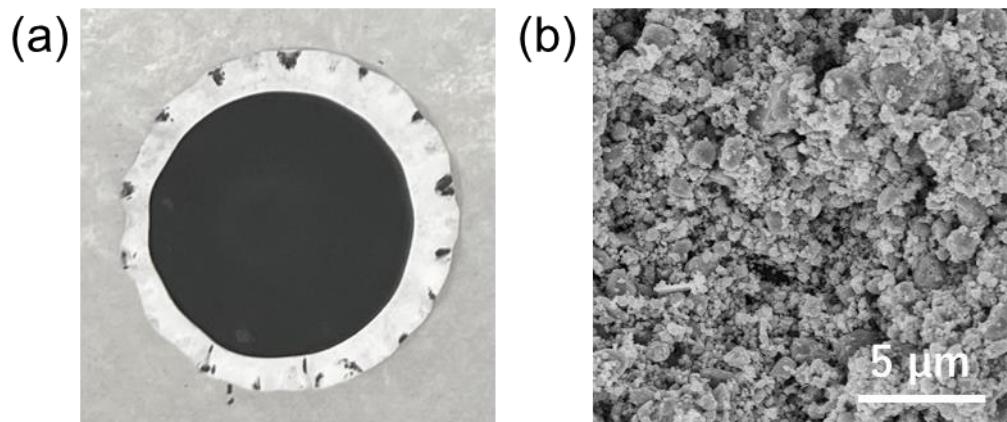


Figure S3. Cold-pressed $\text{CoSb}_{2.95}\text{Te}_{0.05}$ powder film: (a) digital photo image; (b) SEM image.

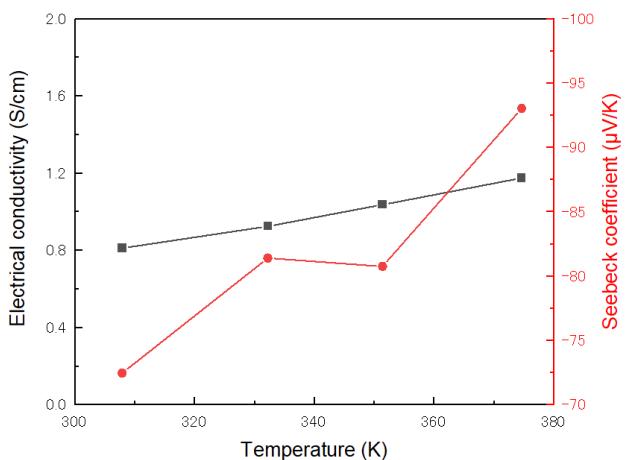


Figure S4. Electrical conductivity and the Seebeck coefficient of the 98wt% $\text{CoSb}_{2.95}\text{Te}_{0.05}$ hybrid film with increasing temperature

Table S3. Thermoelectric properties of the $\text{CoSb}_{3-x}\text{Te}_x$ ($x = 0.05, 0.10, 0.15$) bulk sample at room temperature.

	Seebeck coefficient	Electrical conductivity	Power factor
	[$\mu\text{V}/\text{K}$]	[S/cm]	[$\mu\text{W}/\text{m K}^2$]
$x=0.05$	-179	1050	3350
$x=0.10$	-139	1360	2620
$x=0.15$	-124	1550	2370

References

- Li, Z.; Sun, H.; Hsiao, C.; Yao, Y.; Xiao, Y.; Shahi, M.; Jin, Y.; Cruce, A.; Liu, X.; Jiang, Y.; et al. A Free-Standing High-Output Power Density Thermoelectric Device Based on Structure-Ordered PEDOT:PSS. *Adv. Electron. Mater.* **2018**, *4*, 1–8.